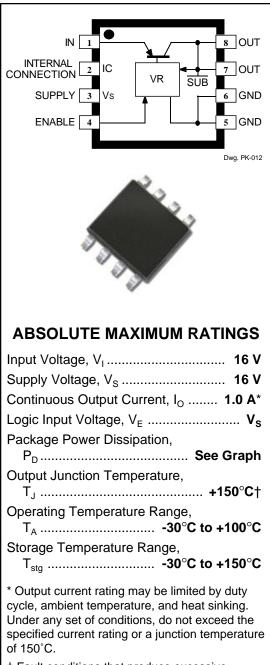


SI-3018LSA



† Fault conditions that produce excessive junction temperature will activate the device's thermal protection circuitry. These conditions can be tolerated but should be avoided.

LOW-VOLTAGE, HIGH-CURRENT 1.8 V LINEAR REGULATOR

The SI-3018LSA is designed to meet the requirement for increased integration and reliability in low-voltage, high-current, linear regulator applications such as personal computers (PCs) and set-top boxes. Each device incorporates a monolithic low-level reference and control circuit with a high-current pnp transistor in a power multi-chip module (PMCMTM). Regulated output voltages of 2.5 V or 3.3 V are also available.

The high-current pass element provides an output current to 1 A. Regulator accuracy of ± 2 % and excellent temperature characteristics are provided. The logic-compatible ENABLE input gives the designer complete control over power up, power down, and standby or sleep.

These devices are supplied in a fully molded 8-lead miniature surface-mount package (tape and reel) with enhanced power-dissipating qualities. They are rated for continuous operation between -30°C and +100°C.

FEATURES

- 1 A Output Current
- LSTTL/CMOS-Compatible On/Off Control Less Than 1 μA "Sleep" Current
- Internal Foldback Overcurrent Limiting
- Internal Thermal Protection
- Surface-Mount Package

Always order by complete part number: **SI-3018LSA-TL** , where "-TL" indicates tape and reel.

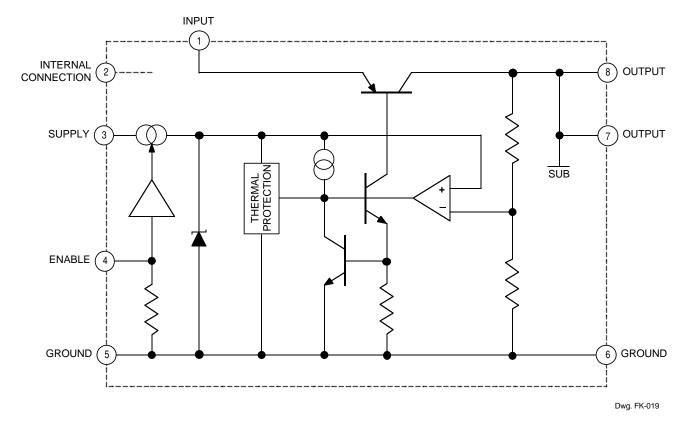


Sanken Power Devices from Allegro MicroSystems





FUNCTIONAL BLOCK DIAGRAM



1.5 ALLOWABLE PACKAGE POWER DISSIPATION IN WATTS 56 5 mm x 56 5 mm COPPER AREA ON GLASS-EPOXY BOARD 1.0 40 mm x 40 mm COPPER AREA ON GLASS-EPOXY BOARD 28 mm x 28 mm COPPER AREA ON GLASS-EPOXY BOARD 0.5 20 mm x 20 mm COPPER AREA ON GLASS-EPOXY BOARD 0 0 20 40 D 60 80 AMBIENT TEMPERATURE in °C 100 120 140 Dwg. GK-010-1

Leads 7 and 8 are soldered to the copper area and provide heat sinking of the pass transistor.

RECOMMENDED OPERATING CONDITIONS

Max. Input Voltage, V ₁	3.5 V
Output Current, Io	0 A to 1.0 A
Output Junction Temperature Range, $\rm T_{\rm J}$	-20 °C to +125°C
Ambient Temperature Range, T _A	30°C to +85°C

For the availability of parts meeting -40°C requirements, contact Allegro's Sales Representative.

This data sheet is based on Sanken data sheet SSJ-01835.



115 Northeast Cutoff, Box 15036 Worcester, Massachusetts 01615-0036 (508) 853-5000 Copyright © 2001, 2005 Allegro MicroSystems, Inc.





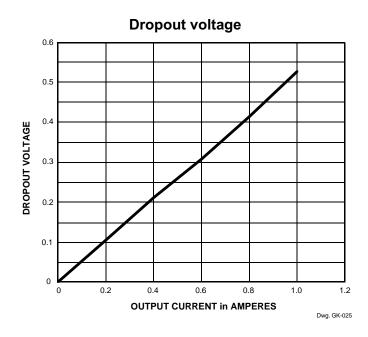
ELECTRICAL CHARACTERISTICS at $T_A = +25^{\circ}C$, $V_I = V_S = 3.3$ V, $V_E = 2.0$ V (unless otherwise noted).

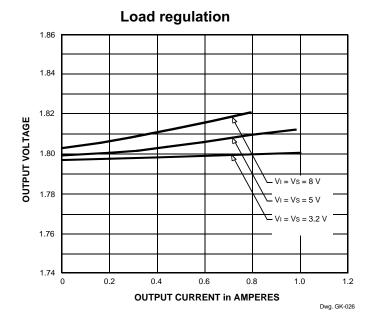
			Limits			
Characteristic	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Output Voltage	Vo	I _o = 500 mA	1.764	1.800	1.836	V
	V _{OQ}	V _E = 0 V, Output Off	_		0.5	V
Output Volt. Temp. Coeff.	a _{vo}	I_{O} = 5 mA, 0°C \leq T _J \leq 100°C	_	±0.3	—	mV/°C
Overcurrent Limit	I _{OM}	$V_{\rm O}$ = 95% of $V_{\rm O}$ at I $_{\rm O}$ = 500 mA	1.2	1.5	_	А
Line Regulation	$\Delta V_{O(\Delta VI)}$	3.1 V \leq V _I = V _S \leq 3.5 V, I _O = 300 mA	—	2.0	10	mV
Load Regulation	$\Delta V_{O(\Delta IO)}$	$0 \le I_0 \le 1 A$	—	10	20	mV
Dropout Voltage	V _I min - V _O	I ₀ ≤ 1 A		0.55	1.2	V
Ground Terminal Current	I _{GND}	I _o = 0 mA	_	1.7	2.5	mA
	۱ _Q	V _E = 0 V, I _O = 0 mA	_		1.0	μΑ
Rejection Ratio	PSRR	100 Hz ≤ f ≤ 120 Hz	_	60	_	dB
ENABLE Input Voltage	V _{EH}	Output On	2.0		_	V
	V _{EL}	Output Off	_		0.8	V
ENABLE Input Current	I _{EH}	V _E = 2 V, Output On	_	30	80	μΑ
	I _{EL}	V _E = 0 V, Output Off	_	0	-5.0	μΑ
Thermal Protection Temp.	TJ		135	150	_	°C
Thermal Resistance	$R_{_{ extsf{ heta}JL}}$	To terminals 7 and 8		36		°C/W

Typical values are at $T_A = +25^{\circ}C$ and are given for circuit design information only.

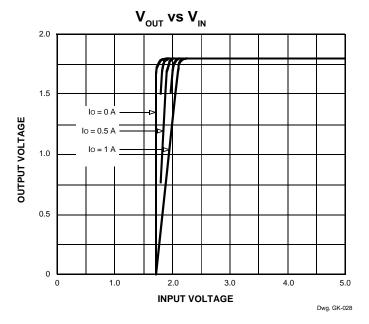


TYPICAL CHARACTERISTICS at $T_A = 25^{\circ}C$





Overcurrent protection 2.0 VI = VS = 3.2 V VI = VS = 5 V 1.5 VI = VS = 6 VOUTPUT VOLTAGE 1.0 0.5 0 0.5 1.0 1.5 2.0 0 **OUTPUT CURRENT in AMPERES** Dwg. GK-027



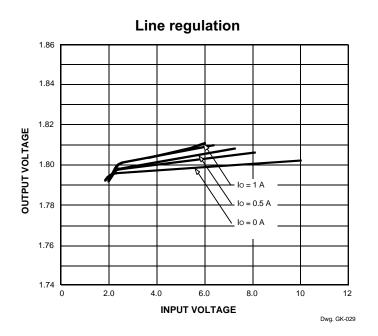


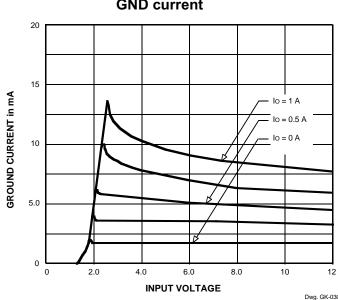
115 Northeast Cutoff, Box 15036 Worcester, Massachusetts 01615-0036 (508) 853-5000





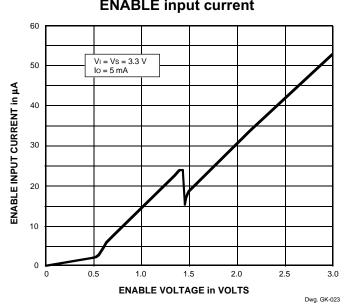






GND current

Dwg. GK-030



ENABLE input current

Littleat Lators

APPLICATIONS INFORMATION

Thermal protection and heat sinking. Thermal protection circuitry turns off the device should the junction temperature rise above 135°C. This is intended only to protect the device from failures due to excessive junction temperatures and should not imply that high-temperature operation is permitted. Ambient temperature is affected by air circulation and proximity to other heat-producing components. Normal operation is resumed when the junction temperature is reduced. Output terminals 7 and 8 are the lead frame and substrate of the pass transistor and provide a low thermal-resistance path for heat sinking.

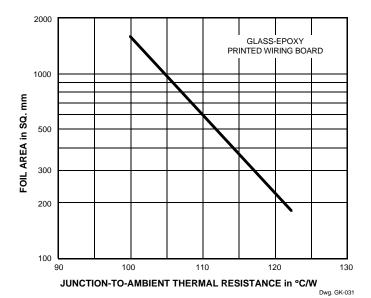
In general, the maximum ambient temperature has the most effect on determining the heat sinking that is needed to maintain a safe normal operating junction temperature. The maximum heat sinking thermal resistance $(R_{\theta JA})$ can be calculated as

 $R_{_{\theta JA}} = (135 - T_{_A}) / I_{_O}(V_{_I} - 1.8)$

where T_A is the maximum ambient temperature in °C, I_O is the maximum output (load) current in amperes, and V_I is the maximum input voltage in volts.

The following graph gives the required copper foil area (soldered to leads 7 and 8) to provide the required thermal resistance. Note that more is always better and both sides of the printed wiring board can be used.

ENABLE input. The ENABLE input includes an internal pull-



<u> Illegro</u>

6

down resistor. If this terminal is not connected (open-circuit fault), the device output is turned off.

Overcurrent protection. The SI-3018LSA includes an overcurrent protection circuit, which limits the output current at start up. It thus cannot be used with

- 1) a constant-current load,
- 2) a power supply with positive and negative to a common load (center-tap type power supply),
- 3) a series power supply, or
- 4) a diode or resistor in series with the device ground to raise the output voltage.

Input voltage. Including ripple voltage and transients, the minimum input voltage should be greater than the sum of the output voltage and the maximum rated dropout voltage; the maximum input voltage must be less than the absolute maximum rated input voltage (16 V).

In most applications, the input voltage (terminal 1, V_{y}) and the supply voltage (terminal 3, V_s) are connected together.

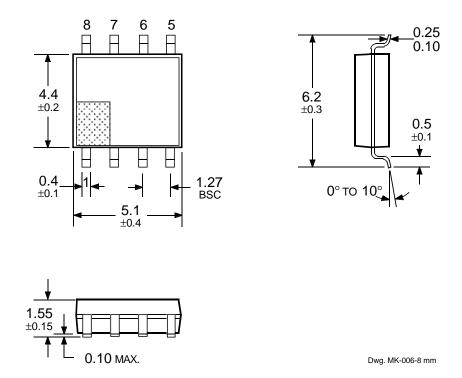
Output capacitor. A 22 µF tantalum electrolytic capacitor is recommended between the output and ground. Very-low ESR capacitors should not be used.

Input capacitor. A 0.1 μ F to 10 μ F tantalum capacitor is recommended between the input and ground to prevent oscillation.



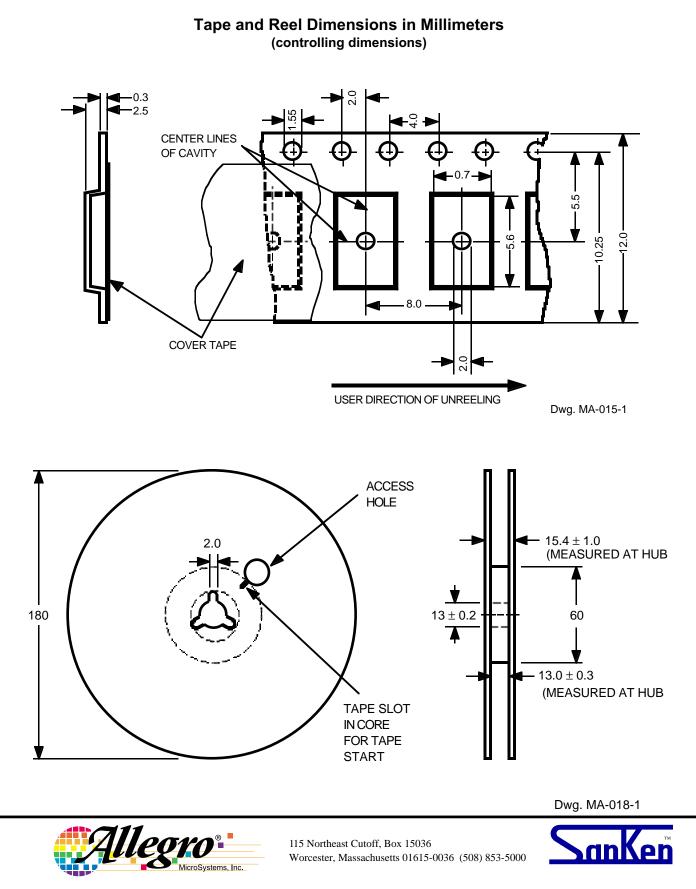


Dimensions in Millimeters (controlling dimensions)



- NOTES: 1. Exact body and lead configuration at vendor's option within limits shown.
 - 2. Lead spacing tolerance is non-cumulative.
 - 3. Leads 7 and 8 are internally connected together and provide heat sinking of the pass transistor.







The products described herein are manufactured in Japan by Sanken Electric Co., Ltd. for sale by Allegro MicroSystems, Inc.

Sanken and Allegro reserve the right to make, from time to time, such departures from the detail specifications as may be required to permit improvements in the performance, reliability, or manufacturability of its products. Therefore, the user is cautioned to verify that the information in this publication is current before placing any order.

When using the products described herein, the applicability and suitability of such products for the intended purpose shall be reviewed at the users responsibility.

Although Sanken undertakes to enhance the quality and reliability of its products, the occurrence of failure and defect of semiconductor products at a certain rate is inevitable.

Users of Sanken products are requested to take, at their own risk, preventative measures including safety design of the equipment or systems against any possible injury, death, fires or damages to society due to device failure or malfunction.

Sanken products listed in this publication are designed and intended for use as components in general-purpose electronic equipment or apparatus (home appliances, office equipment, telecommunication equipment, measuring equipment, etc.). Their use in any application requiring radiation hardness assurance (e.g., aerospace equipment) is not supported.

When considering the use of Sanken products in applications where higher reliability is required (transportation equipment and its control systems or equipment, fire- or burglar-alarm systems, various safety devices, etc.), contact a Sanken sales representative to discuss and obtain written confirmation of your specifications.

The use of Sanken products without the written consent of Sanken in applications where extremely high reliability is required (aerospace equipment, nuclear powercontrol stations, life-support systems, etc.) is strictly prohibited.

The information included herein is believed to be accurate and reliable. Application and operation examples described in this publication are given for reference only and Sanken and Allegro assume no responsibility for any infringement of industrial property rights, intellectual property rights, or any other rights of Sanken or Allegro or any third party that may result from its use.